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| | | SHARP CORPORA | ATION | REPRESENTATIVE DIVISION |
| | | | | C) PTO-ELECTRONIC |
| | | CDFCTF | ICATION | DEVICES DIV. |
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| 1 | | DEVICE SPECIFICATION FOR | | |
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| | | Gar Iel Io Radial ty | w-gr een LED pe taoida | |
| | | MODEL No. | E26TP | |
| | | | 22611 | |
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| 1. This sp | ecification | sheets inc lude the contents | under the copyright | t of Sharp Corporat ion ("Sharp"). |
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| devi ces | for an y ap i I d by S!ARP a: | cat ions other than those | applications for gen | era I electronic equipment |
| | • | ` ' | | |
| (1) Inta | uses of thi | esigned for general electro s'device are as follows; | nic equipment. | |
| F · OA | eaui pment | AV equipment Home a | opliance - Telecommu | nicati on 1 |
| equi | pment (Ter | · AV equipment · Home a minal) - Masuring equipme | ent Tooling machin | ne , Computer, etc. |
| (2) PI ea | ise take proj | per steps in order to main | rain reliabil i ty and sa | afety, in case this device |
| | | ne uses mentioned beloww | - | |
| Uni | t concerning | control and safety of a ion breaker • Traffic s | vehicle (sir plane tr | Sin automobile etc.) |
| [• Oth | ier safety equ | ui pment, etc. | THE BOX and | a sargrar arena sox |
| (3) Pleas | se do not us | e for the uses mentioned be | low which require extr | emely high reliabi i ity. |
| - Soa | ce equipment | *Telecommunicat jon equ | inment (Trunk) 1 | , , |
| | lear control | equipment • Medical eq | aipment etc. | |
| | | | | |
| | | | f) ATE | |
| CUSTO | ER'S APPROV | /AL | PRESENTED V | M Abu |
| | | | H. Abe | |
| DAT | E | | Department | General Manager of |
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| LT6E26TP | 1 | ' ' |

L T 6 E 2 6 T P

This data sheet is to introduce the specification of the light emitting dev ice, Model No, LTBE26TP, de livered to

1. Structure and characteristics

Structure: Radial type taping of GLOEG267, GaP Yellow-green LED. the leads are

straight at 18.0mm from the bottom face of resin.

Taping specifications: See Page 3 Packing specifications: See Page 4,5 Taping test: See Page 6

Outline dimensions and pin connections of GLGEG26T: See Page 7

2. Absolute maximum ratings.

(Ta=25C)

| Parameter | Symbol | Value | Unit |
|--------------------------------|--------|------------------------|------|
| Power dissipation | P | 84 | • w |
| Continuous Forward current | ΙF | 3 0 | A |
| Peak forward current (Note 1) | [m | 5 0 | •A |
| Derating factor | | (DC) 0.40 (Pulse) 0,67 | nA∕℃ |
| Reverse voltage | VR | 5 | V |
| Operating temperature | Topr | -25 ∼ + 85 | |
| Storage temperature | Tatg | −25 ~ +100 | r |
| Soldering temperature (Note 2) | Tsol | 260 (within 5 seconds) | |

(Note 1) Duty ratio = 1/10, Pulse width = 0.1 ms

(Note 2) Distance from the bottom of resin: 1.6 mm

3. Electro-optical characteristics

(Ta=25C)

| Parameter | Symbol | Condi tions | Min. | Typ. | Max. | Unit |
|------------------------------|------------------|----------------|------|------|------|------------|
| Forward vo I t 4ge | VF | I- 20 A | 1 | 2.1 | 2.8 | V |
| Luninous intensity (Noto 3) | Ιv | | 60 | 140 | - | mcd mcd |
| Peak emission wavelength | λp | IF = 20 A | | 565 | _ | |
| Spectrum radiation bandwidth | $\Delta \lambda$ | | | 30 | - | 'B |
| 'Reverse current | IR | VR_= 4V | " | - | 1 0 | _ μA |
| Terminal capacitance | C t | V=0V, $f=1MHz$ | - | 35 | - | pF |

(Noto 3) Torelance; ±1 5%

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3. When an LED lampis mounted directly on PUB

If the bottom face of an LED lamp is mounted directly on single-sided PUB, the base of the lead pins may be subjected to physical stress due to PWB warp, cutting or clinching of lead pins.

Prior touse, be sure to check that no disconnection inside of the resin or damage to resin etc., is found.

when an LED lamp is mounted on double-sided PWB, the heat during soldering affects the resin; therefore, keep the LED lamp more than 1.6mm affoat shove the PWB.

4. Others

If any problem should arise from this specification, $|t|h_{\rm e}$ supplier and user should work out a nutually acceptable solution.

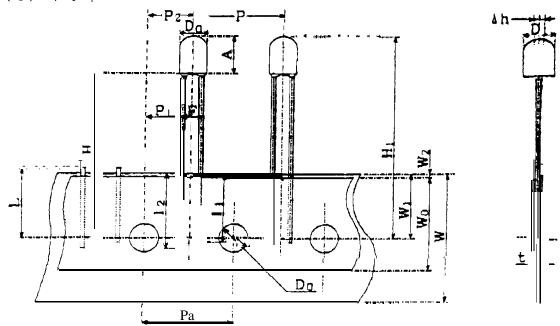
MODEL No.

LT6E26TP

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(1) Taping specifications



| Parameter | Symbol | Dimensions(mm) | Remark |
|--------------------------------------------------------------------------|----------------|----------------|----------|
| lamp diameter(Short) | Do | 34.8 ±0.2 | |
| lamp diameter(Long) | Dı | ♦5,8 ±0,2 | |
| Lamp height | A | 7.7 ±0.2 | |
| Lead dismeter | d P | 0.5 ±0.1 | |
| Device spacing(Center to center) | P | 12.7 ±1.0 | |
| Hole pitch (Center to center) | P. | 12.7 ±0.3 | 8 |
| Hole location | P, | 5,08±0.7 | |
| | P ₂ | 8.35±1.3 | 1 |
| Lead spacing (Center to center) | F | 2,54 MIN | <u> </u> |
| Inclination | <u>an</u> | 0.0 ±2.0 | С |
| Tape width | W | 18,0 ± 5.3 | |
| Adhesive tape width | Wo | 13.0 ±0.3 | |
| Hole center to tape edge | W. | 9.0 ±0.5 | |
| Adhesive tape edge to tape edge | W_2 | 1.0以下 | |
| Lamp bottom to hole center | H | 18.0 ±1.0 | |
| Total lengit | H. | 25.7 ±0.5 | |
| Covered lead lengit | | 13.5 以上 | |
| | 12 | 14.5 DE | |
| Hole diameter | D. | 44.0 ±0.2 | |
| Lead lengit after rejective defective product | L | 11.0以下 | |
| Tape thickness(total) emark- a.Dimension allowance a must be lam or less | t | 0.7 ±0.2 | <u>d</u> |

b.Measuring point shall be delow the resin.
c.Measuring point shall be the lamp top.
d. The base sheet is 0.37±0.1 in thickness.

%Lamp specifications:SeePege 7

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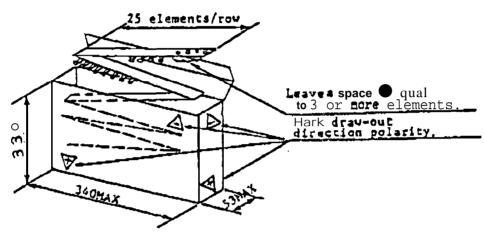
(2) Packing Specification

1. Packing form

Box type

- a) Folding type of a radial-type taping dimension (separately discussed) to length of 25 elements per rev.
- b) Leave a space equal to 3 or-more elements at both ends of the tape. Model No., luminous intensity rank and polarity are printe.
- G) Distinguish cathode draw-out method from anode draw-out ethod, according to light-emitting diode polarity.

 The former corresponds to the upper lid opening method on d the latter corresponds co the lower lid opening method.



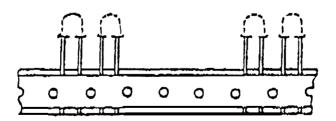
*Insert cushion material between produce and upper or lover lid of the case.

2. Packing quantity

2,000 elements per **Case** (standard)

3. Missing • lements

Three or leas consecutive ullet lements may be $\begin{tabular}{l} \begin{tabular}{l} is \$\$ng, as shown below. \end{tabular}$

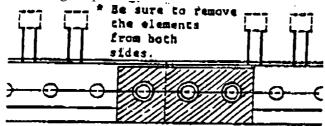


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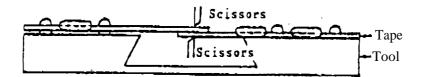
4. Connecting

1) To connect the 'tapes(case of finishing or cutting the tape), cut the tape ends end connect them using connecting tape, as shown below.

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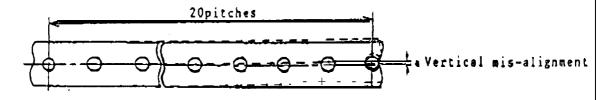
- 2) Ma or points of connecting
 - ① Cutting the tape Attach the tapes to tool, as shown below, and cut at the center between Peed holes of both tapes using scissors.



2 Connecting the tape After cutting, connect the tapes using the connecting tape under the condition of attaching themto the tool.

3) Accuracy of connecting

The connecting tape should not cover the feed holes (D.). And total tape thickness(t) must be less than 1.5 and after connect Dimension allowance "a" must be less than lam per 20 pitches.



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| 1 | LT6E26TP | " | 6. |

(3) Taping Test

| No. | Items | Test Method | Performance Criteria |
|-----|-----------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------|
| 1 | Lead wire strength | Apply 100g load in the direction shown by the arrow above for 3 sec. ±1. | In accordance with Specifications for Inserted Parts. |
| | | Apply 100g load in the direction shown by the arrow above for 3 sec. ±1. | In accordance with Specifications for Inserted Parts |
| 2 | Adhesive test | 1) Strength test Fixed Apply 500g load in the direction shown by the arrow for 3 sec. ±1. 2) Life test Let sample stand at normal temperature and humidity for 6 months. | Lead Wire must not be out of place or missing |

